# AN5790N, AN5792

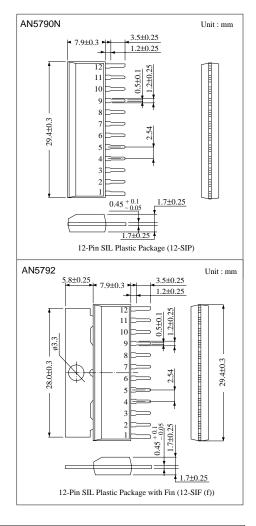
Horizontal Signal Processing ICs for CRT Display

#### Overview

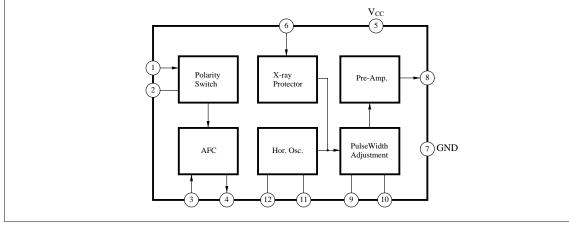
The AN5790N and AN5792 are the intergrated circuits designed for CRT display horizontal signal processing circuits.

- Features
- Horizontal synchronous signal is available in both polarities.
- Wide range of horizontal osciallation frequency : 14kHz to 60kHz.
- $\bullet$  Output pulse width : 2µs to 40µs
- Package

AN5790N...NF-12S(12-Pin SIL plastic package) AN5792...F-12S (12-Pin SIL plastic package with fin)



#### Block Diagram



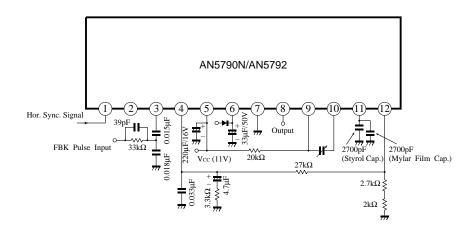
Parameter		Symbol	Rating	Unit	
Supply voltage		V <sub>CC</sub>	13.2	V	
Supply current		I <sub>CC</sub>	50	mA	
Power dissipation		PD	1140	mW	
Tommonotumo	Operating ambient temperature	$T_{opr}$	- 20 to +70	°C	
Temperature	Storage temperature	$T_{stg}$	- 40 to +150	°C	

## ■ Absolute Maximum Ratings (Ta= 25°C)

## ■ Electrical Characteristics (Ta= 25°C)

Parameter	Symbol	Condition	min	typ	max	Unit
Total circuit current	I <sub>tot</sub>	V <sub>CC</sub> =11V	30	45	60	mA
Polarity switching voltage (1)	V <sub>2-7</sub>	Positive polarity signal input	0	—	0.4	V
Polarity switching voltage (2)	V <sub>2-7</sub>	Negative polarity signal input	2.5		5.5	V
Horizonal oscillation start voltage	V <sub>OSC-S (H)</sub>	f <sub>HO</sub> =12kHz to 19kHz	7.5	—		V
Horizonal oscillation frequency	$f_{HO(1)}$	V <sub>CC</sub> =11V, C=4400pF	15	15.75	16.5	kHz
Horizonal oscillation frequency	$f_{HO(2)}$	V <sub>CC</sub> =11V, C= 820pF, 5600pF	14		60	kHz
f <sub>HO</sub> supply voltage dependency	$\Delta f_{HO}/V_{CC}$	$f_{HO}$ =15.75kHz, $f_{HO}$   9.9V- $f_{HC}$   12.1V		40	130	Hz
f <sub>HO</sub> ambient temperature dependency	$\Delta f_{HO}/Ta$	$f_{HO}$ =15.75kHz, $f_{HO} \mid -20^{\circ}C - f_{HC} \mid 60^{\circ}C$			260	Hz
Oscillation frequency control sensitivity	β	$\Delta I_{O} = \pm 25 \mu A$	16	17.6	19.3	Hz/µA
DC loop gain	$f_{DC}$	$\mu \times \beta$		700		Hz/µs
Output pulse width	$\tau_{\rm HO(1)}$	$V_{CC}=11V, R=20k\Omega, C=6800pF$	17.8	19.4	21.2	μs
Output pulse width	$\tau_{\rm HO(2)}$	V <sub>CC</sub> =11V, R=20kΩ, C=330pF, 18000pF	2		40	μs
Output pulse width variation to supply voltage change	$\Delta\tau_{HO}\!/V_{CC}$	$V_{CC} = 9.9V$ to 12.1V	—		5	%
Output pulse width variation to temeprature change	$\Delta \tau$ <sub>HO</sub> /Ta	$V_{CC}=11V$ , Ta=-20°C to + 60°C			5	%
Oscillation output saturation voltage	V <sub>8-7</sub>	V <sub>CC</sub> =11V, V <sub>10-7</sub> =1V			2	V
Oscillation output drive current	I <sub>8-7</sub>	V <sub>CC</sub> =11V, V <sub>10-7</sub> =1V	300			mA
X-ray protecting circuit operation start voltage	V <sub>6-7</sub>	V <sub>CC</sub> =11V	0.5	0.64	0.75	V

# Application Circuit



# Pin Descriptions

Pin No.	Pin name	Typ. waveform	Description	Equivalent circuit
1	Horizontal synchronous signal input pin	<sup>5V</sup>	Pin for inputting a horizontal syn- chronous signal.	1 4kΩ 777 5V 777 5V
2	Polarity discrimination switching pin	DC	Both polarities of an input signal of Pin1 are made available by connect- ing this pin to GND or setting it to OPEN	2 4kΩ 777 5V 777 5V 777
3	Flyback pulse input pin	$\sim$	Flyback feedback pin. The standard value of amplitude is 1.5Vpp.	3 
4	AFC output pin	DC	Result of AFC detection.	
5	Supply voltage	DC		
6	X-ray protecting circuit input pin	DC	When a voltage of 0.75V or more is applied, no horizonal output will not be generated.	6 200Ω 777
7	GND	DC		
8	Horizontal drive output pin		Current when turned ON should be used at 300mA or less.	(8) 680Ω 2Ω 777

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## ■ Pin Descriptions (cont.)

Pin No.	Pin name	Typ. waveform	Description	Equivalent circuit	
9	Trigger input pin		The output pulse width can be changed by the capacitance		
10	Pulse width adjusting pin		between Pins9 and 10 and resistance between Pin10 and $V_{CC}$ .		
11	Sawtooth wave generating pin	$\sim \sim$	Oscillation frequency can be changed by the capacitor to be connected to this pin.		
12	Horizontal oscillation circuit reference voltage	DC	Oscillation frequency is changed by the resistor between this pin and GND.	(12) ,3.3V	

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